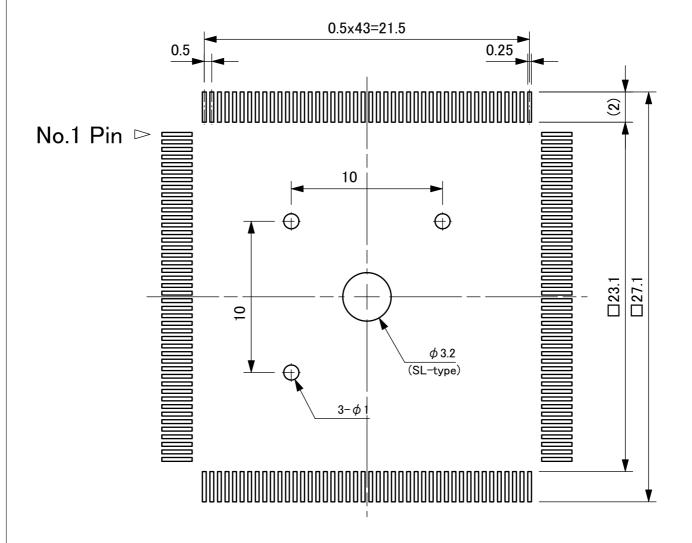
## Recommended a Footprint pattern of NQPACK176SD-ND



\* Recommended foot pattern shown on left is for NQPACK soldering.

But please refer to IC package foot pattern recommended by IC manufacturer also, when the package is soldered on the same foot pattern.

Part No.	NQPACK176SD-ND
IC package	Square
Pin count	176Pin
Lead pitch	0.5
Unit	mm
Design / Date	M.Miura / Feb.24.'12
TET TOKYO ELETECH CORP.	